

# BY550G-400

## GLASS PASSIVATED JUNCTION RECTIFIER

VOLTAGE: 400V

CURRENT: 5.0A



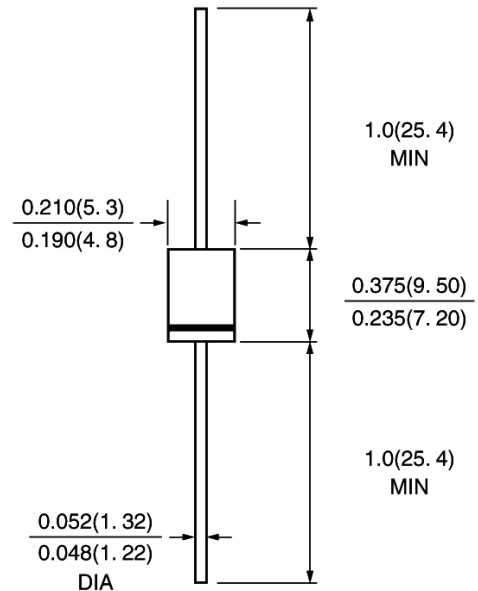
### FEATURE

Molded case feature for auto insertion  
High current capability  
Low leakage current  
High surge capability  
High temperature soldering guaranteed  
250°C /10sec/0.375" lead length at 5 lbs tension  
Glass Passivated chip

### MECHANICAL DATA

Terminal: Plated axial leads solderable per  
MIL-STD 202E, method 208C  
Case: Molded with UL-94 Class V-0 recognized Flame  
Retardant Epoxy  
Polarity: color band denotes cathode  
Mounting position: any

### DO - 201AD



Dimensions in inches and (millimeters)

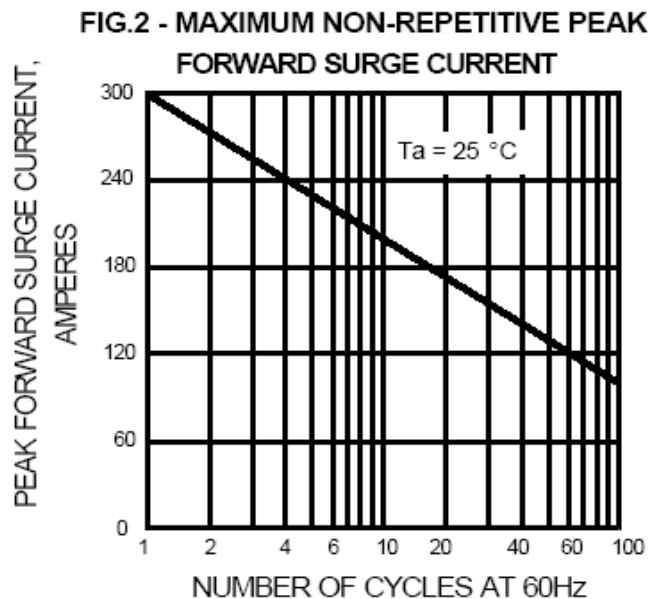
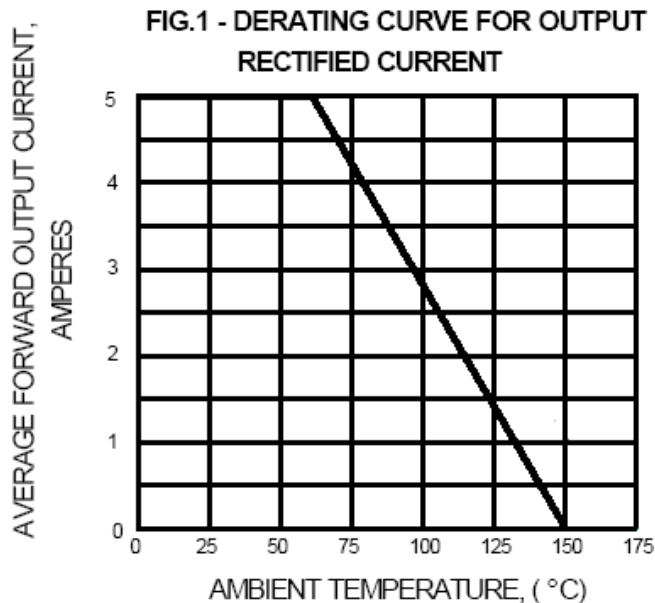
## MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

(single-phase, half-wave, 60HZ, resistive or inductive load rating at 25°C, unless otherwise stated, for capacitive load, derate current by 20%)

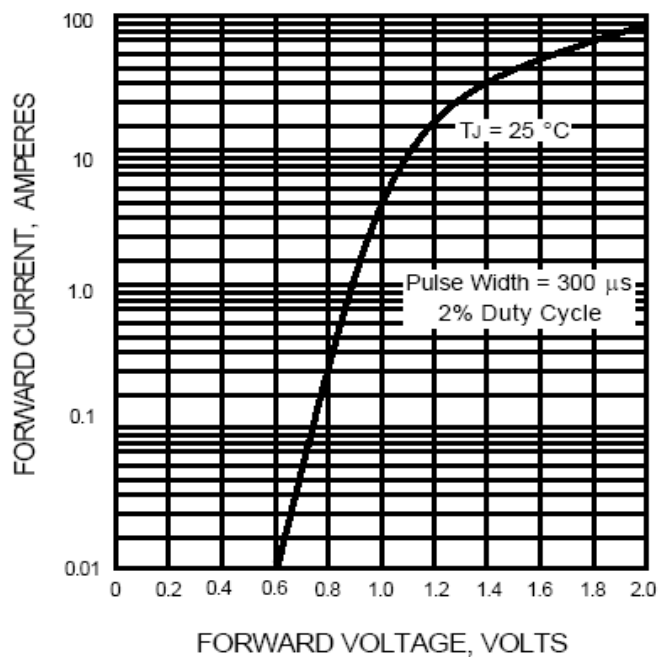
	SYMBOL	BY550G-20S	units
Maximum Recurrent Peak Reverse Voltage	V <sub>rrm</sub>	400	V
Maximum RMS Voltage	V <sub>rms</sub>	280	V
Maximum DC blocking Voltage	V <sub>dc</sub>	400	V
Maximum Average Forward Rectified Current 3/8" lead length at Ta =60°C	I <sub>f(av)</sub>	5.0	A
Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load	I <sub>fsm</sub>	300.0	A
Maximum Instantaneous Forward Voltage at rated forward current	V <sub>f</sub>	1.15	V
Maximum DC Reverse Current at rated DC blocking voltage Ta =25°C Ta =125°C	I <sub>r</sub>	20.0 200.0	μA
Typical Junction Capacitance (Note 1)	C <sub>j</sub>	50	pF
Operating Temperature (Note 2)	R <sub>th(ja)</sub>	18	°C/W
Storage and Operating Junction Temperature	T <sub>stg, Tj</sub>	-55 to +150	°C

Note:

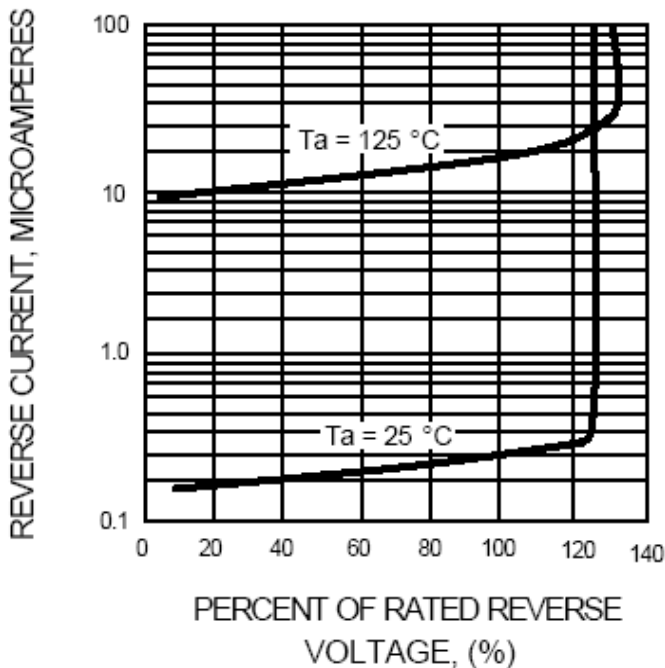
1. Measured at 1.0 MHz and applied voltage of 4.0Vdc
2. Thermal Resistance from Junction to Ambient at 0.375" lead length, P.C. Board Mounted



**FIG.3 - TYPICAL FORWARD CHARACTERISTICS**



**FIG. 4 - TYPICAL REVERSE CHARACTERISTICS**



**FIG. 5 - TYPICAL JUNCTION CAPACITANCE**

